



## Mark Information for SOIC-8 Package

Top Mark	Bottom Mark
CLC2600 YYWW QZ  ●	N/A

where CLC2600 is the base part number.

### Notes:

YY = Last two digits of year

WW = Work week of assembly

Q = Assembly location code

Z = Wafer lot designator supplied by CADEKA purchase order

Mark is specified as content only; layout and justification is per assembly supplier specification

Assembly Location Code	
ASSEMBLY LOCATION	CODE
Unisem Ipoh, Malaysia	A
Unisem Chengdu, China	B